



YOUSHANG SEMICONDUCTOR

**设计研发新型功率器件**

**各类小信号开关**

**中低压及高压大电流等场效应管**

0755-83047638

ysbdt@szyoushang.cn

www.szyoushang.cn



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## Features

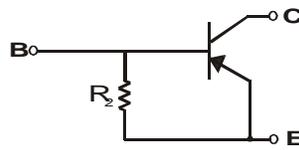
- Epitaxial Planar Die Construction
- Complementary NPN Types Available (DDTC)
- Built-In Biasing Resistor, R2 Only

Part Number	R2 (NOM)
NK-DDTA114GE	10k $\Omega$
NK-DDTA124GE	22k $\Omega$
NK-DDTA144GE	47k $\Omega$
NK-DDTA115GE	100k $\Omega$

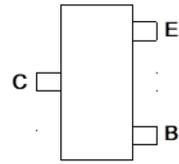
SOT523



Top View



Device Schematic



Package Pin Out Configuration

## Mechanical Data

- Case: SOT523
- Case Material: Molded Plastic, "Green" Molding Compound
- UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish—Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 (B3)
- Weight: 0.002 grams (Approximate)

### Absolute Maximum Ratings (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	$V_{CBO}$	-50	V
Collector-Emitter Voltage	$V_{CEO}$	-50	V
Emitter-Base Voltage	$V_{EBO}$	-5	V
Collector Current	$I_C$ (Max)	-100	mA

### Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	$P_D$	150	mW
Thermal Resistance, Junction to Ambient Air (Note 5)	$R_{\theta JA}$	833	$^\circ\text{C}/\text{W}$
Operating and Storage Temperature Range	$T_J, T_{STG}$	-55 to +150	$^\circ\text{C}$

Note: 5. Mounted on FR4 PC Board with minimum recommended pad layout.

**Electrical Characteristics** (@T<sub>A</sub> = 25°C unless otherwise specified)

Characteristic		Symbol	Min	Typ	Max	Unit	Test Condition
Collector-Base Breakdown Voltage		BV <sub>CB0</sub>	-50	—	—	V	I <sub>C</sub> = -50μA
Collector-Emitter Breakdown Voltage		BV <sub>CEO</sub>	-50	—	—	V	I <sub>C</sub> = -1mA
Emitter-Base Breakdown Voltage		BV <sub>EBO</sub>	5	—	—	V	I <sub>E</sub> = -720μA, NK-DDTA114GE I <sub>E</sub> = -330μA, NK-DDTA124GE I <sub>E</sub> = -160μA, NK-DDTA144GE I <sub>E</sub> = -72μA, NK-DDTA115GE
Collector Cutoff Current		I <sub>CB0</sub>	—	—	-0.5	μA	V <sub>CB</sub> = -50V
Emitter Cutoff Current	NK-DDTA114GE NK-DDTA124GE NK-DDTA144GE NK-DDTA115GE	I <sub>EBO</sub>	-300 -140 -65 -30	—	-580 -260 -130 -58	μA	V <sub>EB</sub> = -4V
Collector-Emitter Saturation Voltage		V <sub>CE(sat)</sub>	—	—	-0.3	V	I <sub>C</sub> = -10mA, I <sub>B</sub> = -0.5mA
DC Current Transfer Ratio	NK-DDTA114GE NK-DDTA124GE NK-DDTA144GE NK-DDTA115GE	h <sub>FE</sub>	30 56 68 82	—	—	—	I <sub>C</sub> = -5mA, V <sub>CE</sub> = -5V
Shunt Resistor (R <sub>2</sub> ) Tolerance		ΔR <sub>2</sub>	-30	—	+30	%	—
Gain-Bandwidth Product (Note 6)		f <sub>T</sub>	—	250	—	MHZ	V <sub>CE</sub> = -10V, I <sub>E</sub> = 5mA, f = 100MHZ

Note: 6. Transistor—for reference only.

Typical Curves—DDT114GE

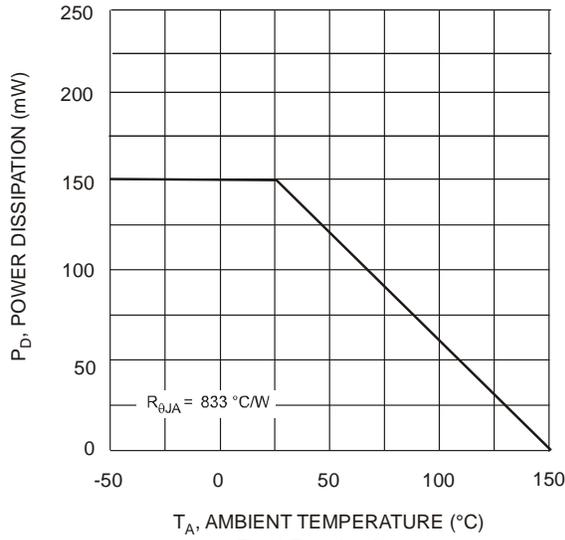


Fig. 1 Derating Curve

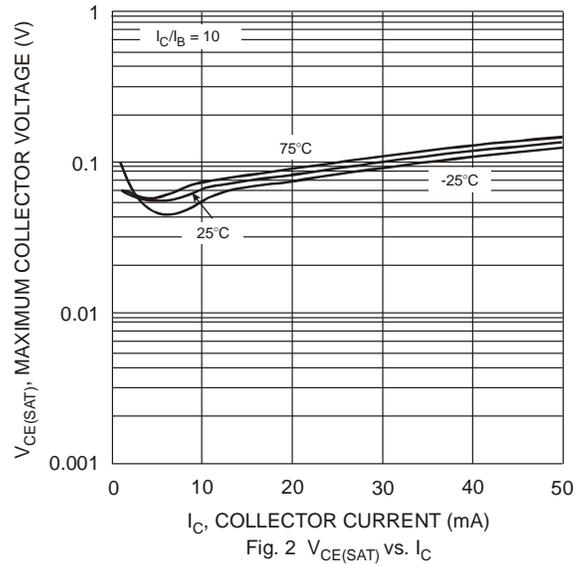


Fig. 2  $V_{CE(SAT)}$  vs.  $I_C$

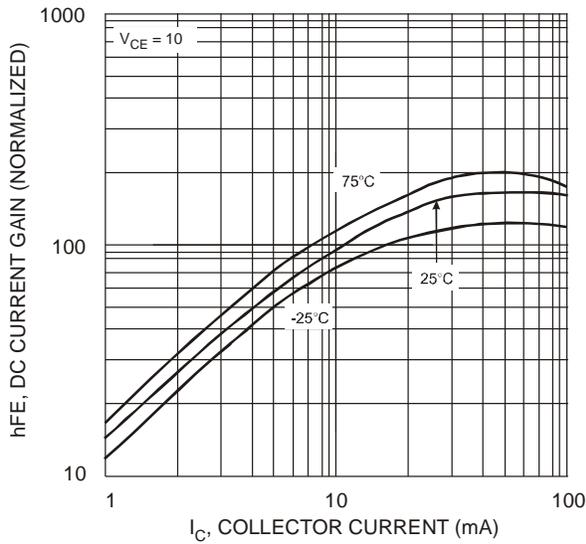


Fig. 3 DC Current Gain

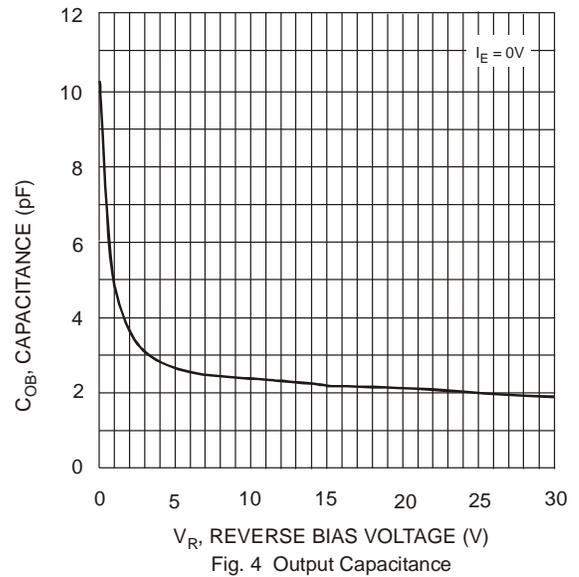


Fig. 4 Output Capacitance

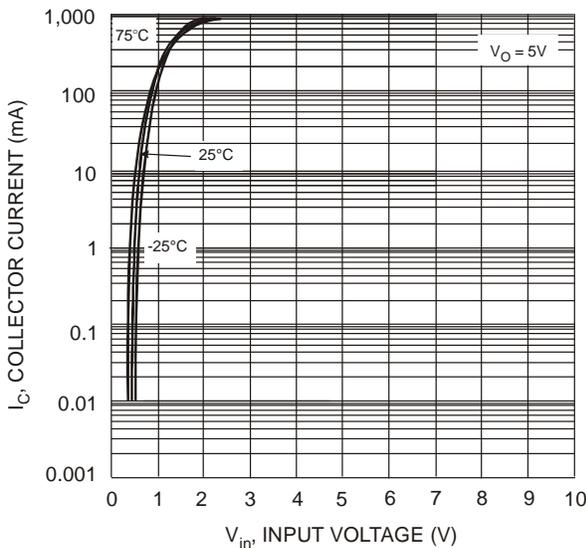


Fig. 5 Collector Current vs. Input Voltage

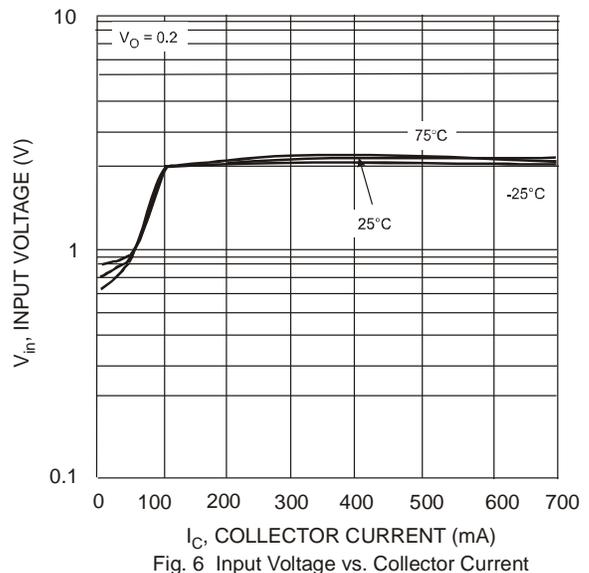
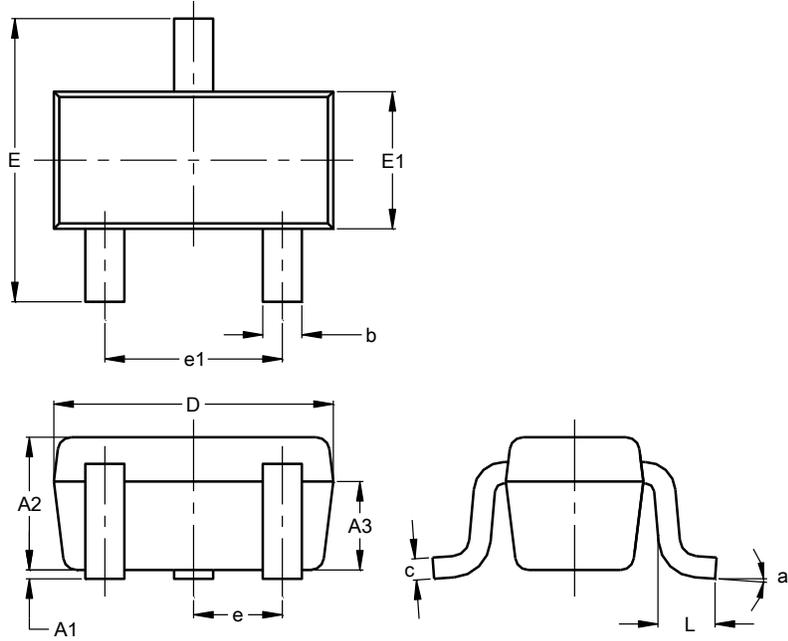


Fig. 6 Input Voltage vs. Collector Current

### Package Outline Dimensions

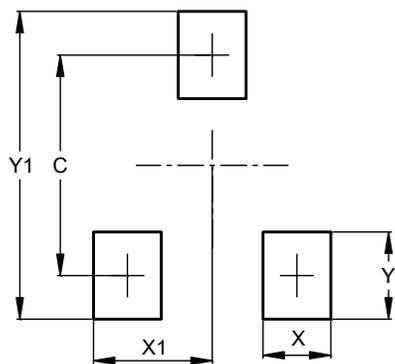
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SOT523			
Dim	Min	Max	Typ
A1	0.00	0.10	0.05
A2	0.60	0.80	0.75
A3	0.45	0.65	0.50
b	0.15	0.30	0.22
c	0.10	0.20	0.12
D	1.50	1.70	1.60
E	1.45	1.75	1.60
E1	0.75	0.85	0.80
e	0.50 BSC		
e1	0.90	1.10	1.00
L	0.20	0.40	0.33
a	0°	--	8°
All Dimensions in mm			

### Suggested Pad Layout

SOT523



Dimensions	Value (in mm)
C	1.29
X	0.40
X1	0.70
Y	0.51
Y1	1.80